

Product Change Notification / ASER-10MDZB313

Date:

16-Mar-2023

Product Category:

Crypto Memory

PCN Type:

Manufacturing Change

Notification Subject:

CCB 5370 Initial Notice: Qualification of S703LS as an additional die attach material for selected AT88S and AT88A device families available in SCC (12.6x11.4x0.58mm) package.

Affected CPNs:

ASER-10MDZB313_Affected_CPN_03162023.pdf ASER-10MDZB313_Affected_CPN_03162023.csv

Notification Text:

PCN Status:Initial Notification

PCN Type: Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of S703LS as an additional die attach material for selected AT88S and AT88A device families available in SCC (12.6x11.4x0.58mm) package.

Pre and Post Change Summary:

	Pre Change	Post Change		
Assembly Site	AIC Semiconductor	AIC Semiconductor	AIC Semiconductor	

	Sdn Bhd (AIC)	Sdn Bhd (AIC)	Sdn Bhd (AIC)		
Wire Material	Au	Au	Au		
Die Attach Material	2035SC	2035SC	S703LS		
Molding Compound Material	1650	1650	1650		
Lead-Frame Material	Epoxy Glass Film base with Copper	Epoxy Glass Film base with Copper	Epoxy Glass Film base with Copper		

Impacts to Data Sheet:None

Change Impact:None

Reason for Change:To improve on time delivery performance by qualifying S703LS as an additional die attach material.

Change Implementation Status: In Progress

Estimated Qualification Completion Date: April 2023

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

Time Table Summary:

	December 2022			>	April 2023						
Workweek	4 9	5 0	5 1	5 2	5 3		14	15	16	17	18
Initial PCN Issue Date			х								
Qual Report Availability											х
Final PCN Issue Date											х

Method to Identify Change:Traceability code

Qualification Plan:Please open the attachments included with this PCN labeled as PCN_#_Qual_Plan.

Revision History:December 09, 2022: Issued initial notification.

March 16, 2023: Re-issued initial notification to update the Die attach material from S703LT to S703LS. Update

the timetable summary to reflect new qualification date from December 2022 to April 2023.

Attachments:

PCN ASER-10MDZB313_Qual Plan.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our PCN home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the PCN FAQ section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. Affected Catalog Part Numbers (CPN)

AT88SC1003-09JT-02 AT88SC1003-09ET-01 AT88SC1003-09ET-00 AT88SC0104C-MPTG AT88SC0204C-MPTG AT88SC0404C-MPTG AT88SC0808C-MPTG AT88SC1616C-MPTG AT88SC0104C-MP AT88SC0204C-MP AT88SC0404C-MP AT88SC0808C-MP AT88SC1616C-MP AT88SC0104C-MJTG AT88AA001-MJ AT88AA001-MJTG AT88SC0204C-MJTG AT88SC0404C-MJTG AT88SC0808C-MJTG AT88AK001-MJ AT88SC1616C-MJTG AT88SC0104C-MJ AT88SC0204C-MJ AT88SC0404C-MJ AT88SC0808C-MJ AT88SC1616C-MJ AT88SC0104C-ME AT88SC0204C-ME AT88SC0404C-ME AT88SC0808C-ME AT88SC1616C-ME AT88SC102-09PT-01 AT88SC102-09ET-17 AT88SC102-09ET-19 AT88SC102-09ET-01 AT88SC102-09ET-03 AT88SC102-09ET-08 AT88SC102-09ET-00 AT88SC1604A-09PT-66 AT88SC153-09PT-00 AT88SC153-09PT-01 AT88SC153-09ET-00 AT88SC1608-09PT-07 AT88SC1608-09PT-01 AT88SC1608-09ET-10 AT88SC1608-09ET-00

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AT88SC3216C-MJTG AT88SC6416C-MJTG AT88SC12816C-MJTG AT88SC25616C-MJTG AT88SC3216C-MJ AT88SC6416C-MJ AT88SC12816C-MJ AT88SC25616C-MJ AT88SC25616C-MB AT88SC0104CA-MPTG AT88SC0204CA-MPTG AT88SC0404CA-MPTG AT88SC0808CA-MPTG AT88SC0104CA-MP AT88SC0204CA-MP AT88SC0404CA-MP AT88SC0808CA-MP AT88SC0104CA-MJTG AT88SC0204CA-MJTG AT88SC0404CA-MJTG AT88SC0808CA-MJTG AT88SC0104CA-MJ AT88SC0204CA-MJ AT88SC0404CA-MJ AT88SC0808CA-MJ